

320A, 100V N-CHANNEL MOSFET

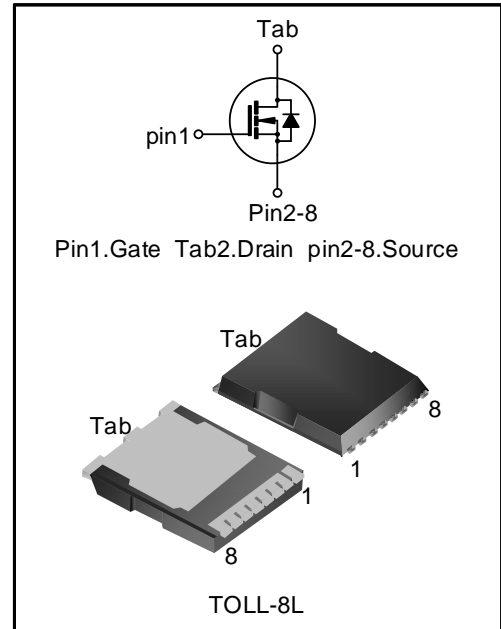
DESCRIPTION

SVGP101R5NL is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance.

This device is widely used in power management for UPS and Inverter Systems.

FEATURES

- ◆ 320A, 100V, $R_{DS(on)(typ.)}=1.1m\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low Crss
- ◆ Fast switching
- ◆ Extreme dv/dt rated
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}	100	V
$V_{GS(th)}$	2.2~3.8	V
$R_{DS(on),max}$	1.5	m Ω
I_D	320	A
$Q_{g,typ}$	238	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVGP101R5NLTR	TOLL-8L	P101R5N	Halogen free	Tape&reel

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Voltage	V_{DS}	--	--	--	100	V
Gate-source Voltage	V_{GS}	--	-20	--	20	V
Drain Current (Note 1)	I_D	$T_C=25^{\circ}\text{C}$	--	--	320	A
		$T_C=100^{\circ}\text{C}$	--	--	210	A
Drain Current Pulsed (Note 2)	I_{DM}	$T_C=25^{\circ}\text{C}$	--	--	1280	A
Power Dissipation (Note 3)	P_D	$T_C=25^{\circ}\text{C}$	--	--	321	W
Single Pulsed Avalanche Energy	E_{AS}	$L=0.1\text{mH}$, $V_{DD}=80\text{V}$, $R_G=25\Omega$, starting temperature $T_J=25^{\circ}\text{C}$	--	--	756	mJ
Single Pulsed Avalanche Current	I_{AS}	--	--	--	123	A
Operation Junction Temperature Range	T_J	--	-55	--	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	--	-55	--	150	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	0.39	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	45	$^{\circ}\text{C}/\text{W}$
Soldering Temperature (SMD)	T_{sold}	Reflow soldering: 10 ± 1 sec, 3times	--	--	260	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^\circ\text{C}$)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100	--	--	V
Drain-source Leakage Current	I_{DSS}	$V_{DS}=100V, V_{GS}=0V, T_J=25^\circ\text{C}$	--	--	1.0	μA
		$V_{DS}=100V, V_{GS}=0V, T_J=125^\circ\text{C}$	--	9.0	--	μA
Gate-source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.2	--	3.8	V
Static Drain-source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=150A$	--	1.1	1.5	$m\Omega$
		$V_{GS}=6.0V, I_D=75A$	--	1.4	2.0	$m\Omega$
Gate Resistance	R_g	$f=1\text{MHz}$	--	2.8	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	$f=1\text{MHz}, V_{GS}=0V, V_{DS}=50V$	--	17694	--	pF
Output Capacitance	C_{oss}		--	2681	--	
Reverse Transfer Capacitance	C_{rss}		--	66	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=50V, V_{GS}=10V, R_G=1.8\Omega, I_D=100A$ (Notes 4,5)	--	47	--	ns
Turn-on Rise Time	t_r		--	85	--	
Turn-off Delay Time	$t_{d(off)}$		--	139	--	
Turn-off Fall Time	t_f		--	78	--	
Total Gate Charge	Q_g	$V_{DD}=50V, V_{GS}=10V, I_D=100A$ (Notes 4,5)	--	239	--	nC
Gate-source Charge	Q_{gs}		--	85	--	
Gate-drain Charge	Q_{gd}		--	40	--	
Gate-plateau Voltage	$V_{plateau}$		--	4.9	--	V

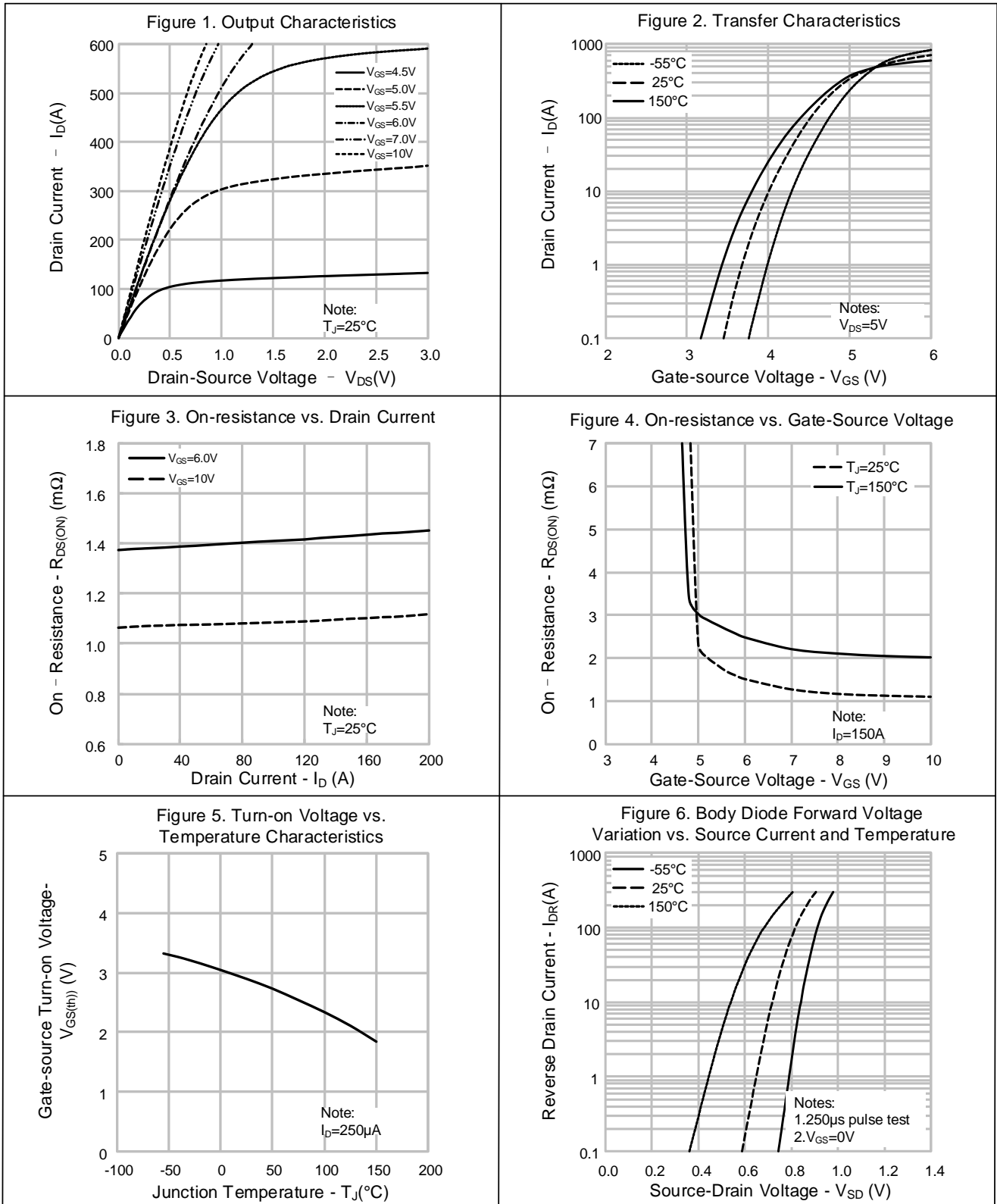
Reverse diode characteristics

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_S	Integral Reverse P-N Junction	--	--	320	A
Diode pulse current	$I_{S,pulse}$	Diode in the MOSFET	--	--	1280	
Diode Forward Voltage	V_{SD}	$I_S=100A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=100A, V_{GS}=0V, V_R=80V$	--	111	--	ns
Reverse Recovery Charge	Q_{rr}	$dI_F/dt=100A/\mu s$ (Note 4)	--	299	--	nC

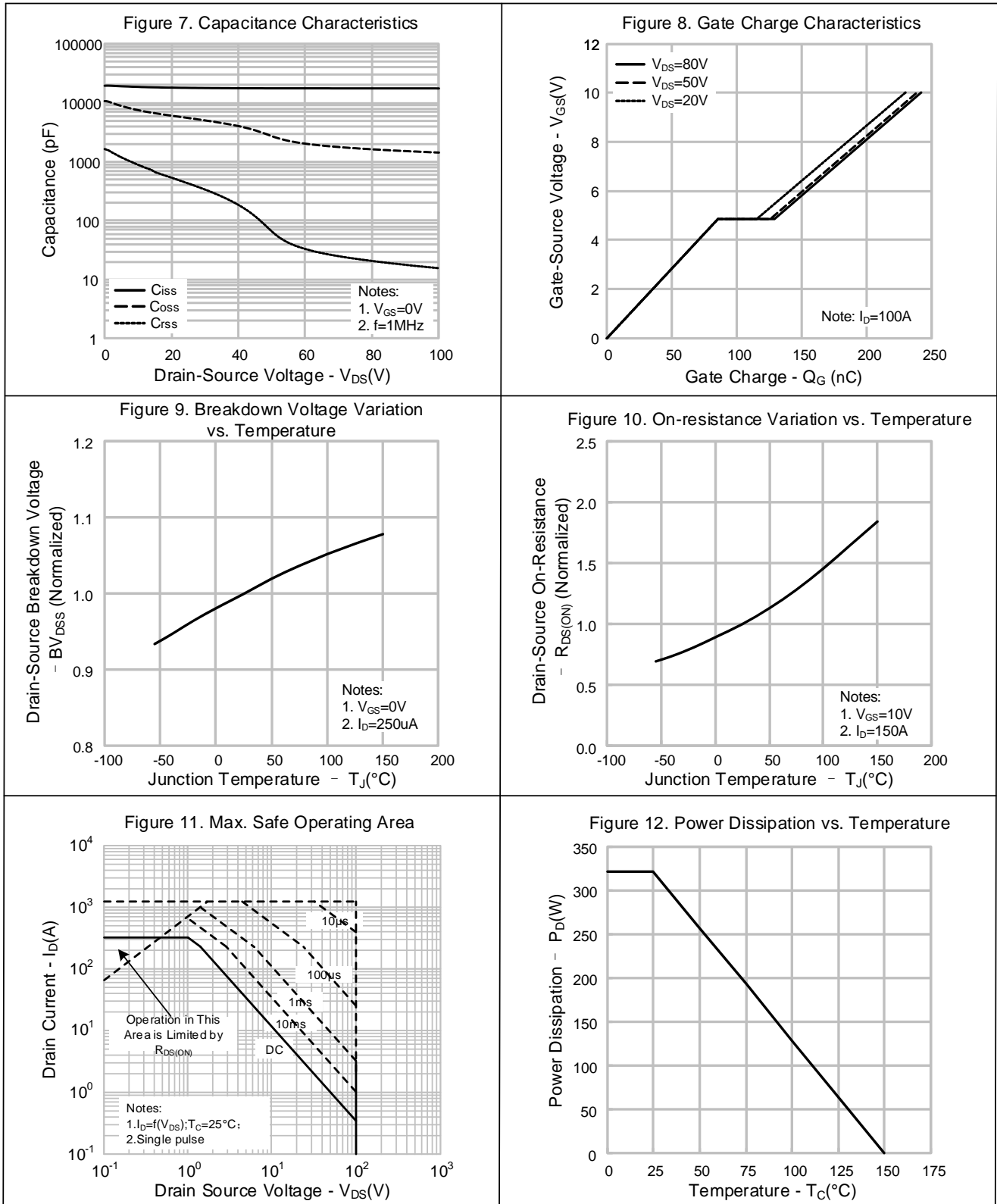
Notes:

- The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C , it should be derated according to the actual environmental conditions;
- Pulse time $5\mu s$;
- The dissipation power will change with temperature, derating above 25°C : $2.56\text{W}/^\circ\text{C}$;
- Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;
- Essentially independent of operating temperature.

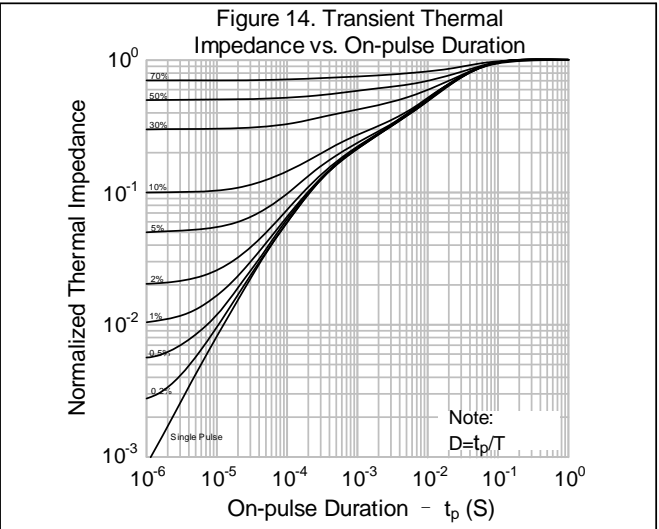
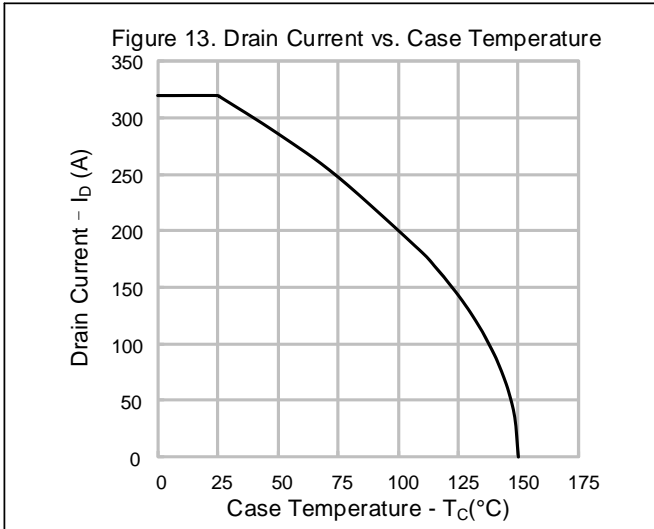
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)

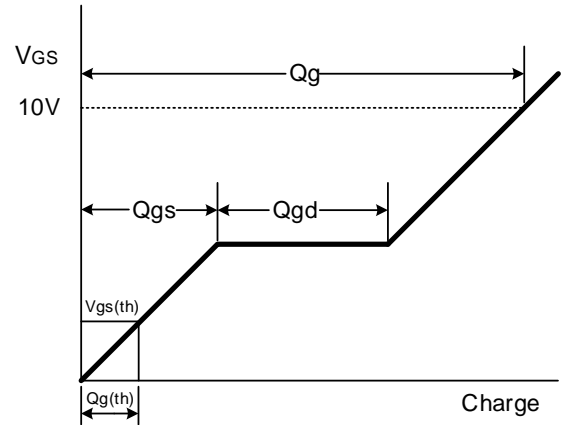
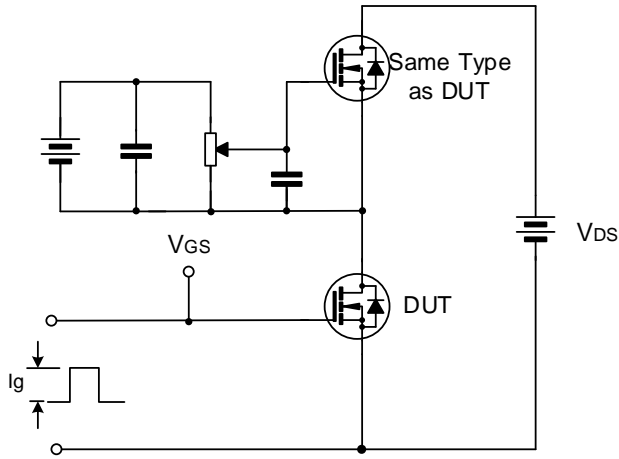


TYPICAL CHARACTERISTICS (CONTINUED)

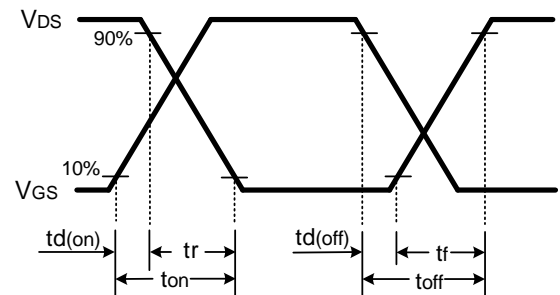
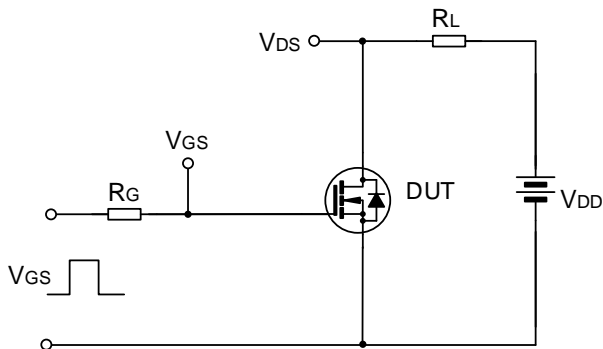


TYPICAL TEST CIRCUIT

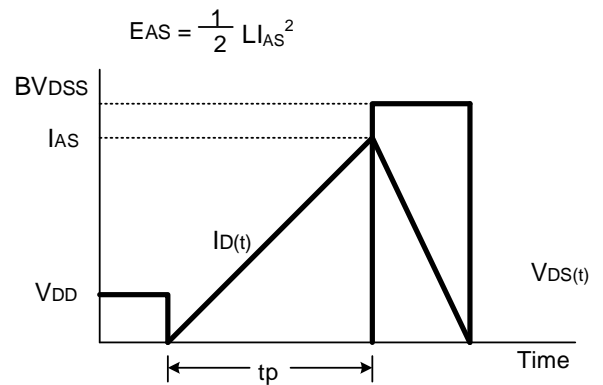
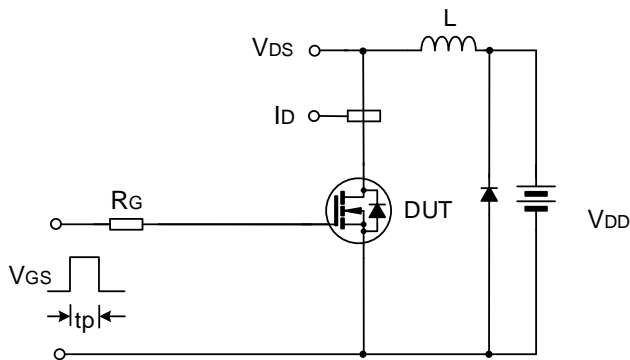
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



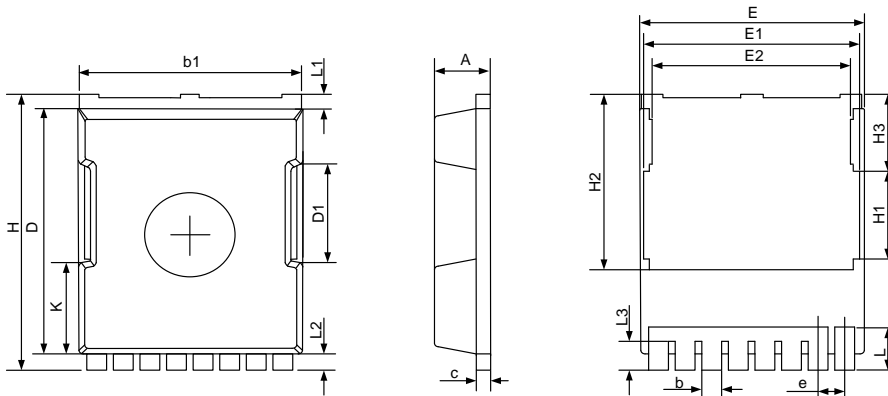
Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE

TOLL-8L

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.20	2.30	2.40
b	0.70	0.80	0.90
b1	9.70	9.80	9.90
c	0.40	0.50	0.60
D	10.28	10.38	10.48
D1	3.15	3.30	3.45
E	9.70	9.90	10.10
E1	9.30	9.50	9.70
E2	8.35	8.50	8.65
e	1.20 BSC		
H	11.48	11.73	11.88
H1	3.16	3.26	3.36
H2	7.20	7.35	7.50
K	4.03	4.18	4.33
L	1.60	1.85	2.10
L1	0.55	0.70	0.85
L2	0.45	0.60	0.75
L3	1.05	1.20	1.30



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Rev: 1.0

Revision History:

1. First release
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